



IEEE Authorship Seminar

Presented by:
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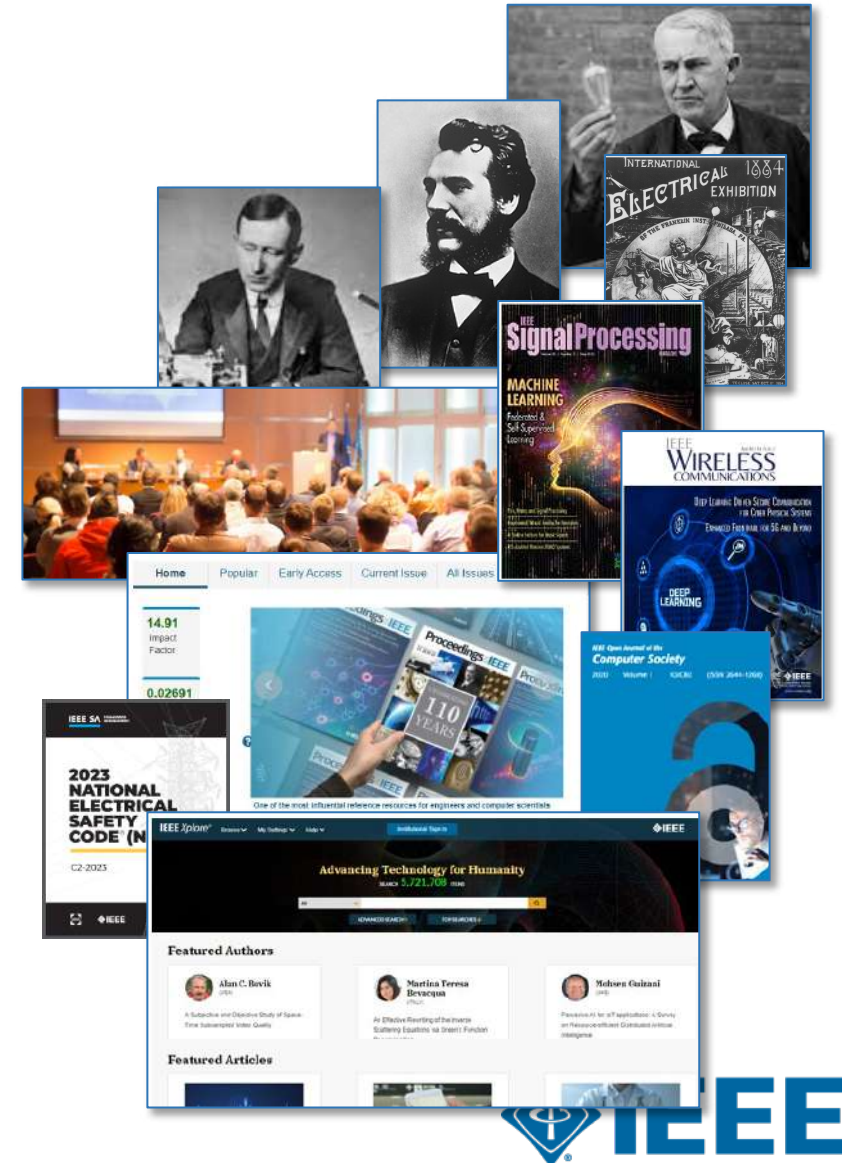


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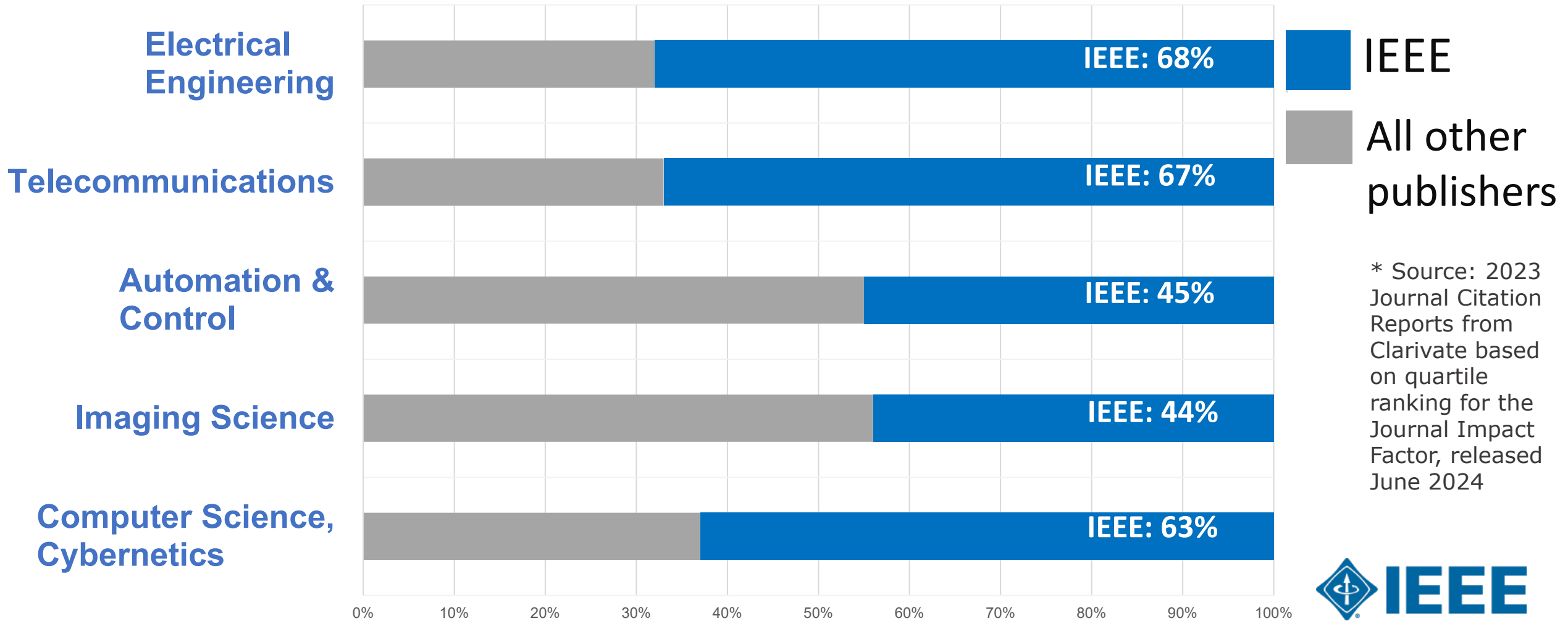
- 21 of the top 25 journals in **Electrical and Electronic Engineering**
- 13 of the top 15 journals in **Telecommunications**
- 5 of the top 10 journals in **Computer Science, Artificial Intelligence**
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5 of Top 10 Cited Journals in AI*

- #2 IEEE Trans. on Pattern Analysis and Machine Intelligence
- #6 IEEE Trans. on Evolutionary Computation
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* Source: 2022 Journal Citation Reports from Clarivate, released June 2023

** Source 1790 Analytics 2023



Additional Journal Bibliometrics...

IEEE Journal Rankings by Eigenfactor

Electrical and Electronic Engineering

IEEE has 9 of the top 10 journals:

1. IEEE Access
2. Sensors
3. IEEE Transactions on Industrial Electronics
4. IEEE Transactions on Pattern Analysis and Machine Intelligence
5. IEEE Transactions on Neural Networks and Learning Systems
6. IEEE Internet of Things Journal
7. IEEE Transactions on Image Processing
8. IEEE Transactions on Vehicular Technology
9. IEEE Transactions on Geoscience and Remote Sensing
10. IEEE Transactions on Power Electronics

Telecommunications

IEEE has the top 10 journals:

1. IEEE Access
2. IEEE Internet of Things Journal
3. IEEE Transactions on Vehicular Technology
4. IEEE Transactions on Wireless Communications
5. IEEE Transactions on Communications
6. IEEE Transactions on Antennas and Propagation
7. IEEE Journal on Selected Areas in Communications
8. IEEE Communications Surveys and Tutorials
9. IEEE Wireless Communications Letters
10. IEEE Communications Letters

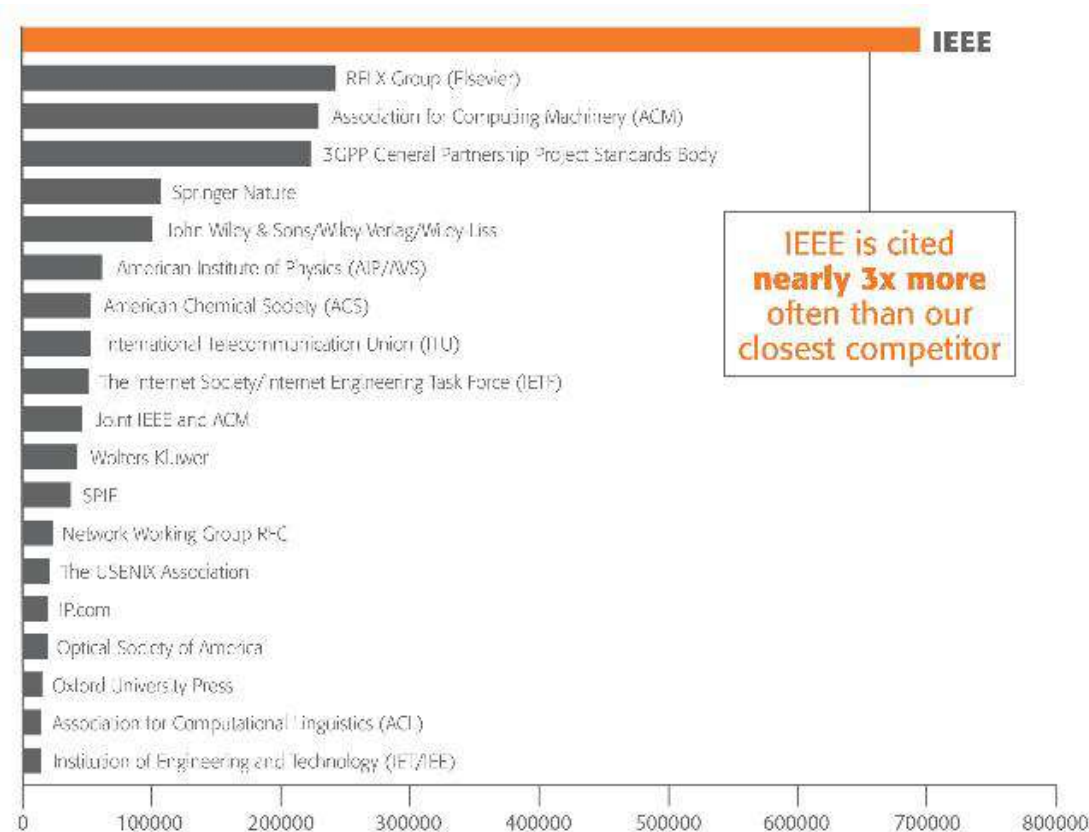


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IEEE is the most-cited publisher in new patents from top patenting organizations.

- Patented technologies are increasingly referencing scientific articles to provide the science base for new inventions
- A 2024 study revealed that IEEE publications received **nearly 3X more** citations than any other publisher.
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Number of U.S. Patent References from Top 50 Companies to Top 20 Publishers



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Operators

Operators

AND

OR

NOT

NEAR

ONEAR

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Search Expression Examples ?

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- Maximum of **25 search terms per search clause**

- **OR:** ("data field": A OR B) **✗**
("data field": A OR "data filed": B) **✓**

- Max 10 wildcards (* or ?)

- **Order of precedence:**

NEAR / ONEAR

NOT

AND

OR

Maximum of 25 search terms per search clause.

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- IEEE has approximately **200 unique journals** covering a wide range of subjects
- **Pro:** IEEE journals are some of the top-cited journals in the field
- **Con:** A high percentage of articles are rejected

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- Conferences are a good choice for your first publication.
- Typically shorter than journal articles, with less detail and fewer references
- With about **2000 conferences** a year, IEEE has many options
- **Pro:** IEEE conferences are recognized as a vital collection of cutting-edge research
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The screenshot shows the IEEE Publication Recommender website. At the top, there are links to IEEE.org, IEEE Xplore Digital Library, IEEE Author Center, IEEE-SA, IEEE Spectrum, and More Sites. The main heading is "IEEE Publication Recommender™" with the tagline "Find the best match for your scholarly article". Below this, there are two columns of bullet points: "Search 190+ periodicals and 1800+ conferences", "Compare critical points such as Impact Factor and Submission-To-Publication Time", and "Get all the key data about IEEE publications at a glance", "Download the results of your search". The main search area is titled "Choose a search type and let Publication Recommender do the work!". It has three radio buttons: "Both Periodicals and Conferences" (selected), "Periodicals only", and "Conferences only". There is a text input field for "Enter keywords, key phrases, or article title". To the right, there is a section for "Extract keywords from your article" with a text area for "Enter your abstract or drag your article file here (PDF, DOC, DOCX, TEX)" and a button "Add your file". Below the search area, there is a "Narrow by date: (Optional)" section with a date picker and a button "Get Recommendation". At the bottom, there is a section "Or, find details for a specific Periodical or Conference:" with a text input field "Enter the name of a periodical or conference". The footer contains links for IEEE.org, Contact & Support, Accessibility, Non-discrimination Policy, Privacy & Opting Out of Cookies, and Feedback. The IEEE logo is also present.

The screenshot shows the IEEE Transactions on Pattern Analysis and Machine Intelligence journal page. The breadcrumb trail is "Browse Journals & Magazines > IEEE Transactions on Pattern A...". The journal title is "IEEE Transactions on Pattern Analysis and Machine Intelligence". There are buttons for "Submit Manuscript", "Add Title To My Alerts", and "Add to My Favorites". Below the title, there are tabs for "Home", "Popular", "Early Access", "Current Issue", "All Issues", and "About Journal". The "Home" tab is selected. The page displays four key metrics: "24.314 Impact Factor", "0.06637 Eigenfactor", "6.75 Article Influence Score", and "36.6 CiteScore". Below these metrics, there is a section titled "Aims & Scope" with a dropdown arrow. To the left of the Aims & Scope section, there is a sidebar with "Author Resources" including "Submission Guidelines", "Submit Manuscript", and "Author Center". The main content area under "Aims & Scope" states: "The IEEE Transactions on Pattern Analysis and Machine Intelligence publishes articles on all traditional areas of computer vision and image understanding, all traditional areas of pattern analysis and recognition, and selected areas of machine intelligence, with a particular emphasis on machine learning for pattern analysis. Areas such as techniques for visual search, document and handwriting analysis, medical image analysis, video and image sequence analysis, content-based retrieval of image and video, face and gesture recognition and relevant specialized hardware and/or software architectures are also covered."

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machine learning

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Title	Open Access Availability	Impact Factor	Submission to Publication Time in <i>Xplore</i>
Neural Networks and Learning Systems, IEEE Transactions on	Open Access Available	14.255	17.6 Weeks
Human-Machine Systems, IEEE Transactions on	Open Access Available	4.124	16.2 Weeks
Pattern Analysis and Machine Intelligence, IEEE Transactions on	Open Access Available	24.314	20.5 Weeks
Artificial Intelligence, IEEE Transactions on	Open Access Available	Not yet available	9.1 Weeks
Computer Magazine	Open Access Available	2.256	Not yet available

2025 International Conference on Machine Intelligence for GeoAnalytics and Remote Sensing (MIGARS)



2 - 4 September 2025 | Bucharest, **Romania** | Event Format: In-person

Sponsors: National University of Science and Technology Politehnica Bucharest; **Romania** Section; **Romania** Section GRS Chapter; **Romanian** Association on Antennas and Propagation

Field of Interest: Computing and Processing; Geoscience; Signal Processing and Analysis

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2025 E-Health and Bioengineering Conference (EHB)

13 - 14 November 2025 | IASI, **Romania** | Event Format: Hybrid (In-person and Virtual)

Sponsors: Institute of Computer Science of **Romanian** Academy, Iasi Branch; International Society for Digital Health and Education; **Romania** Section; **Romania** Section EMB Chapter; **Romania** Section SP Chapter

Field of Interest: Bioengineering; Communication; Networking and Broadcast Technologies; Components, Circuits, Devices and Systems; Computing and Processing; Engineered Materials, Dielectrics and Plasmas; Robotics and Control Systems; Signal Processing and Analysis

2025 25th International Conference on Control Systems and Computer Science (CSCS)



27 - 30 May 2025 | Bucharest, **Romania** | Event Format: Hybrid (In-person and Virtual)

Sponsors: Faculty of Automatic Control and Computers at Politehnica University of Bucharest; **Romania** Section C Chapter; **Romania** Section CS Chapter; **Romania** Section RA Chapter; **Romanian** Society of Control Engineering and Technical Informatics - SRAIT

Field of Interest: Bioengineering; Communication; Networking and Broadcast Technologies; Components, Circuits, Devices and Systems; Computing and Processing; General Topics for Engineers; Robotics and Control Systems; Signal Processing and Analysis

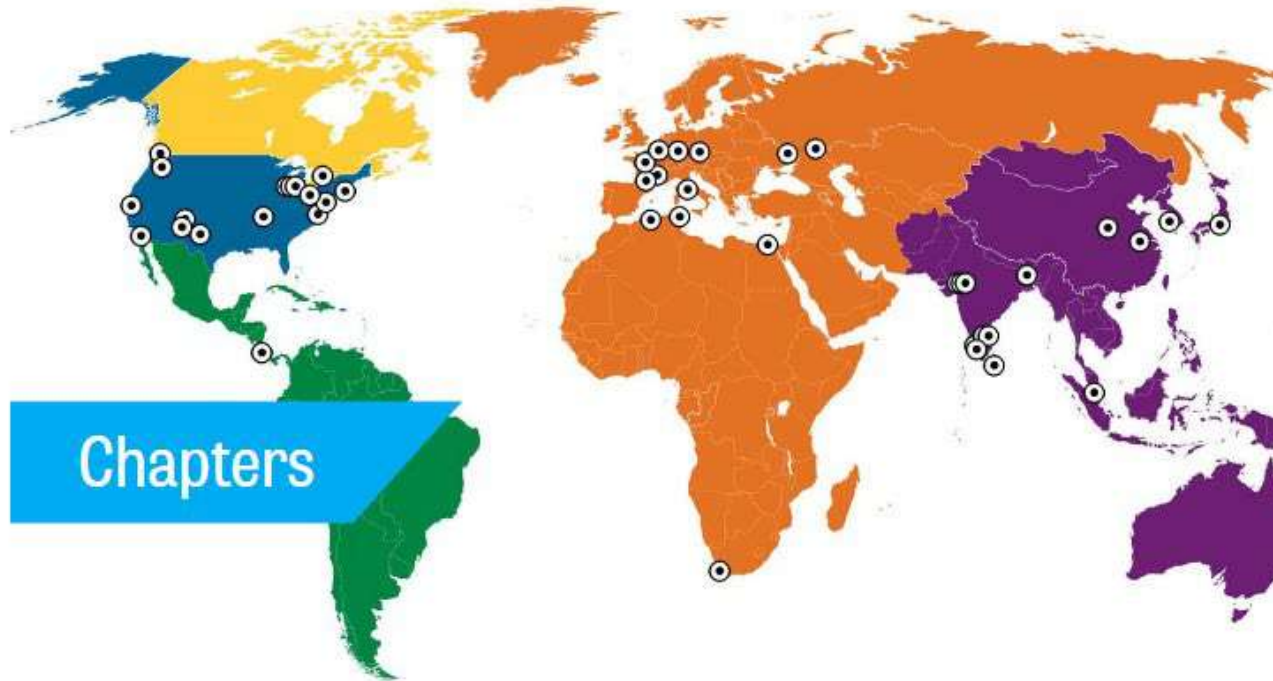
2025 International Conference on Future Energy Solutions (FES)



24 - 25 September 2025 | Cluj-Napoca, **Romania** | Event Format: Hybrid (In-person and Virtual)

Sponsors: **Romania** Section PE Chapter; Technical University of Cluj Napoca

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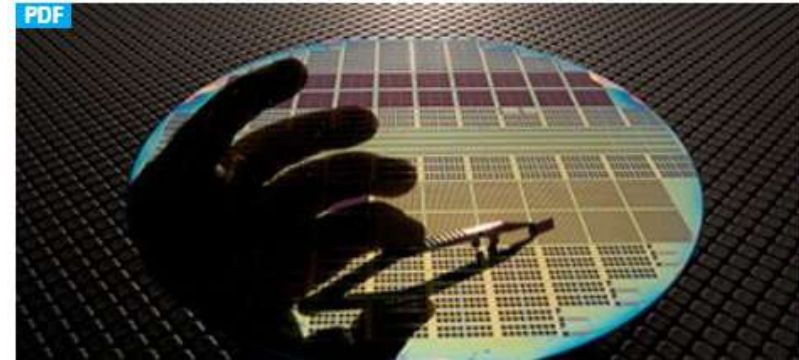
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- ▶ Required Manuscript Content 
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IEEE Transactions on Learning Technologies



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Aims & Scope

The *IEEE Transactions on Learning Technologies* covers all advances in learning technologies and their applications, including but not limited to the following topics: innovative online learning systems; intelligent tutors; educational games; simulation systems for education and training; collaborative learning tools; learning with mobile devices; wearable devices and interfaces for learning; personalized and adaptive learning systems; tools for formative and summative assessment; tools for learning analytics and educational data mining; ontologies for learning systems; standards and web services that support learning; authoring tools for learning materials; computer support for peer tutoring; learning via computer-mediated inquiry, field, and lab work; social learning techniques; social networks and infrastructures for learning and knowledge sharing; and creation and management of learning objects.

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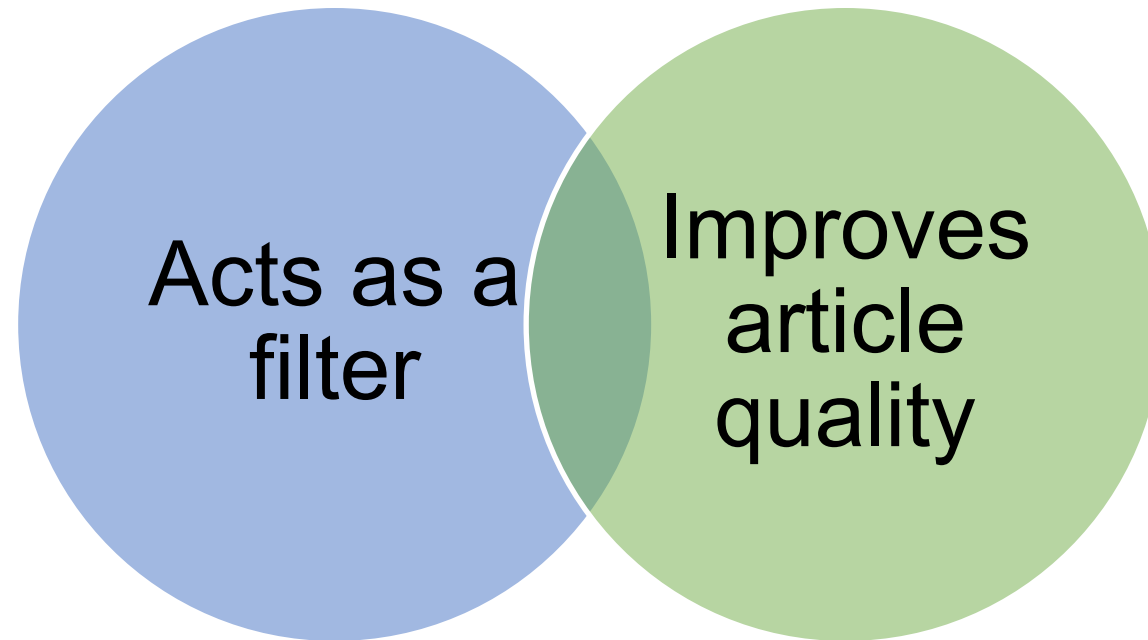
Components of a Typical Article

Title	Specific, concise, descriptive
Abstract	Describe research in 250 words or less
Introduction	Novelty, goal, and motivation
Approach and Results	What you did, how you did it, and what results you obtained
Discussion and Conclusion	What your results mean and areas of further study
References	Proper attribution of previous work

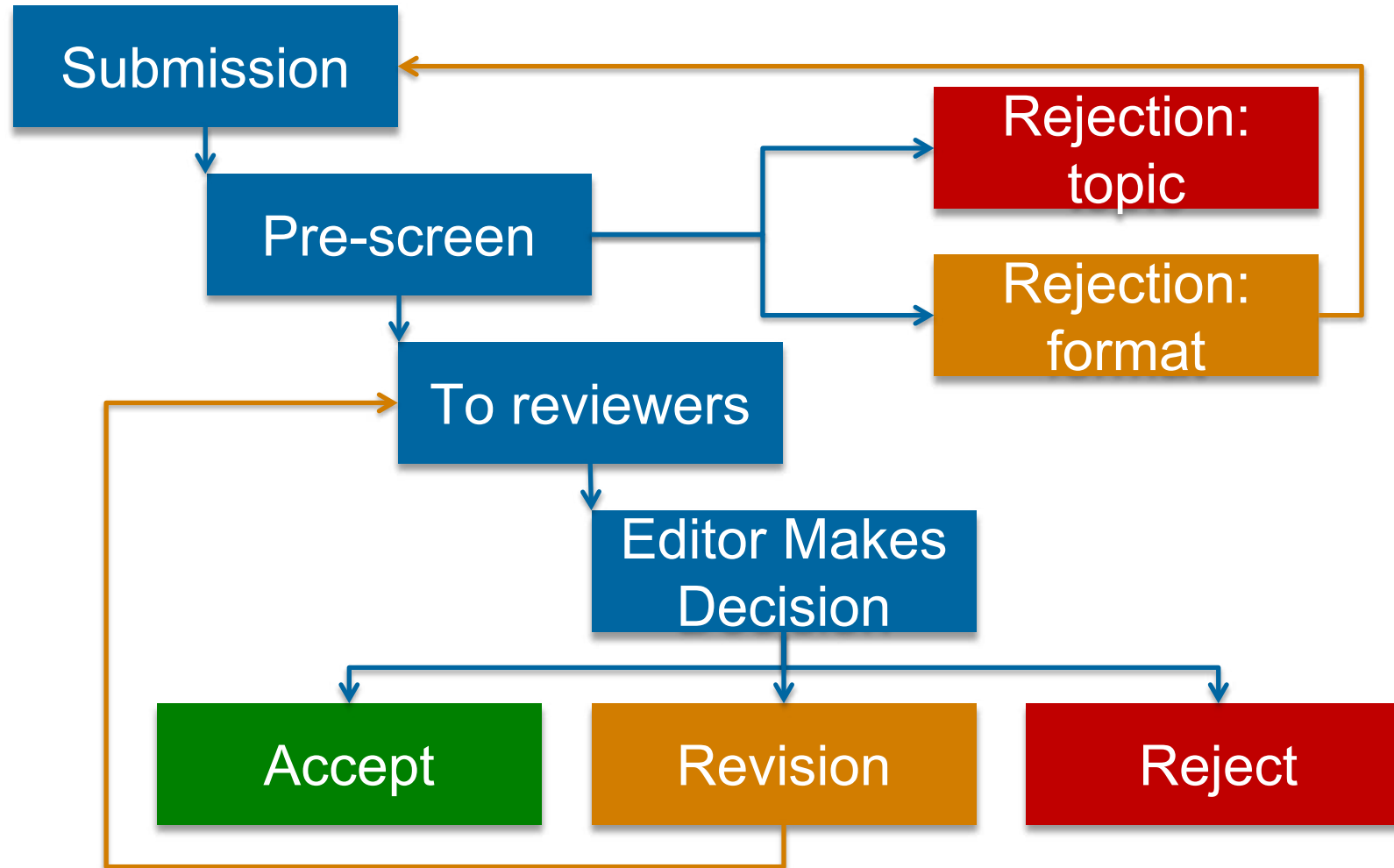
Peer review process and what editors and reviewers are looking for

What is Peer Review?

Peer review is “the critical assessment of manuscripts submitted to [publications] by experts who are not part of the editorial staff.”¹



How It Works



What Reviewers and Editors Look For

Scope

Validity

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Compliance

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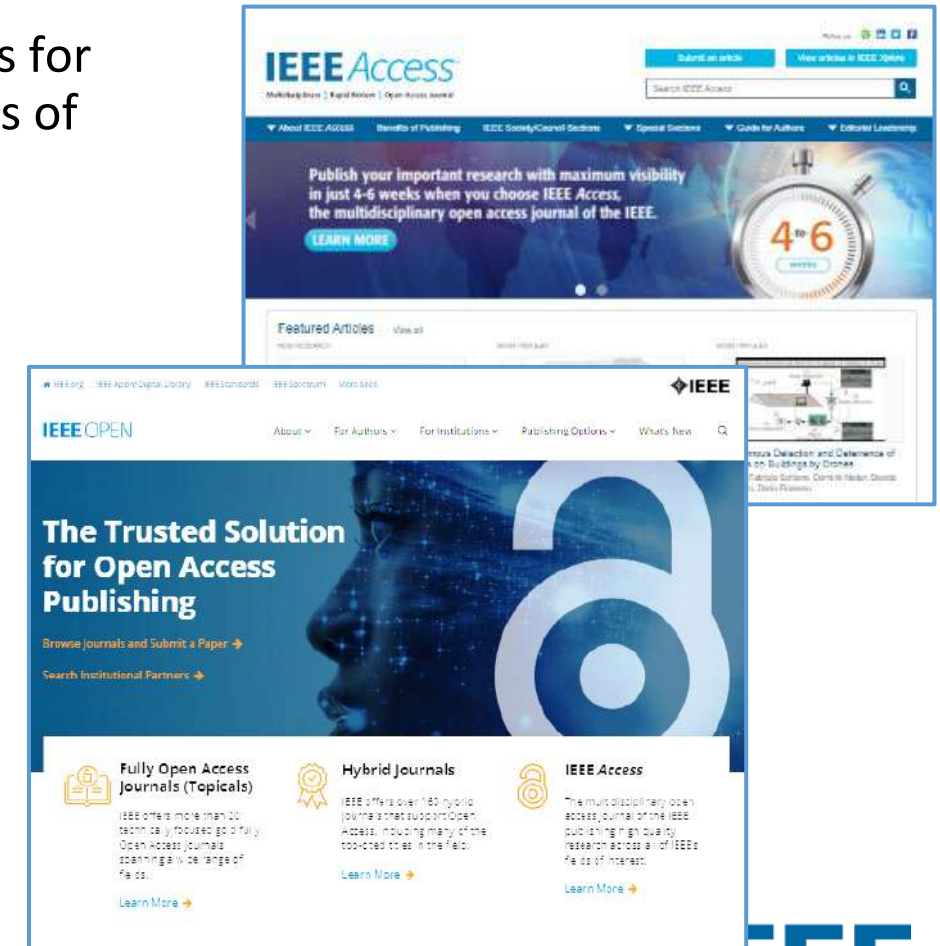
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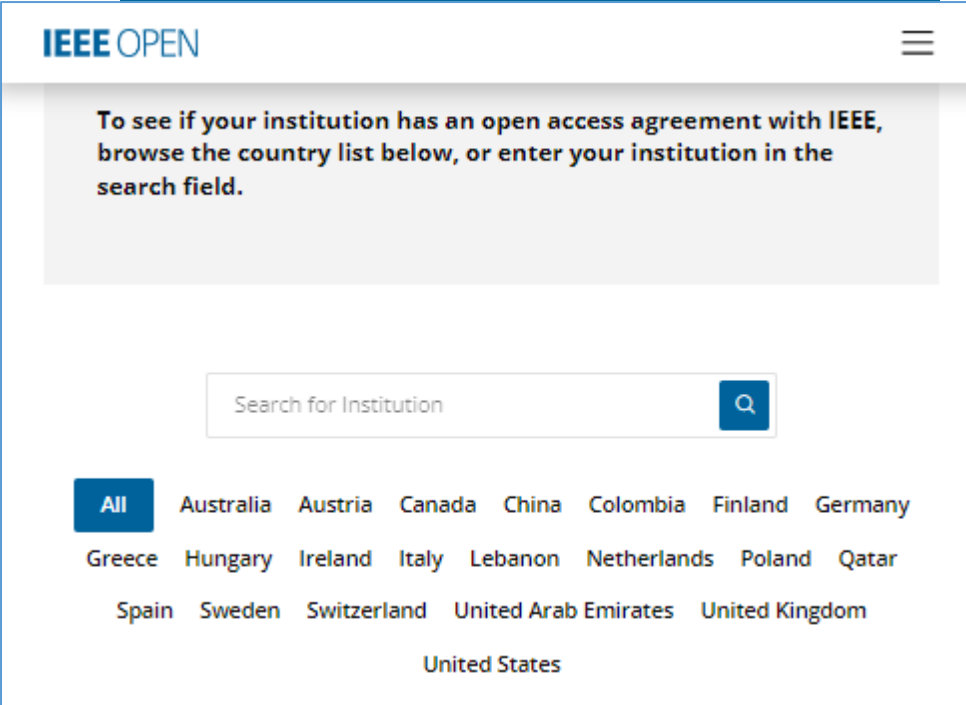
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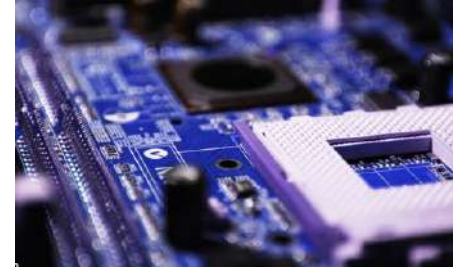
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- *IEEE Reliability Magazine* (2024)
- *IEEE Robotics and Automation Practice* (late 2024)
- *IEEE Transactions on Circuits and Systems for Artificial Intelligence* (late 2024)
- *IEEE Transactions on Field Robotics* (late 2024)
- *IEEE Transactions on Materials for Electron Devices* (2024)

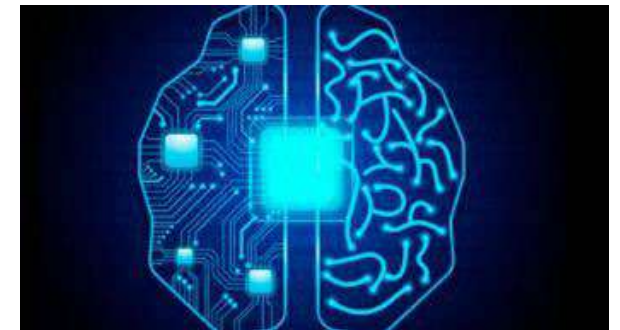
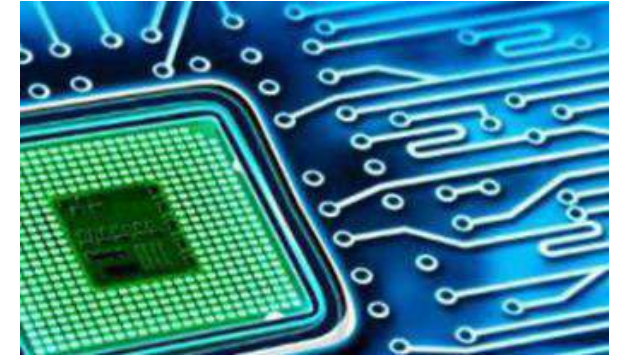


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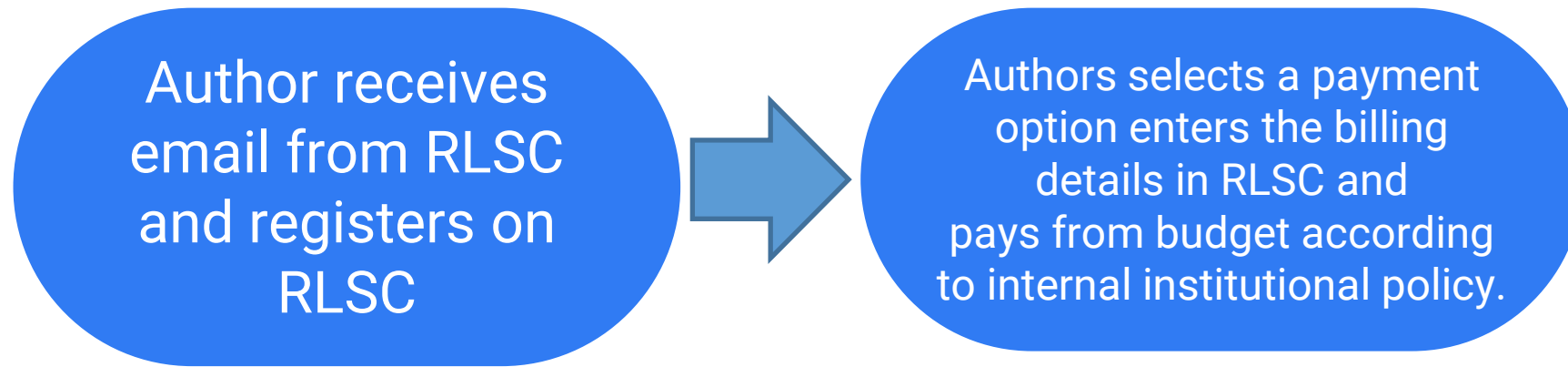


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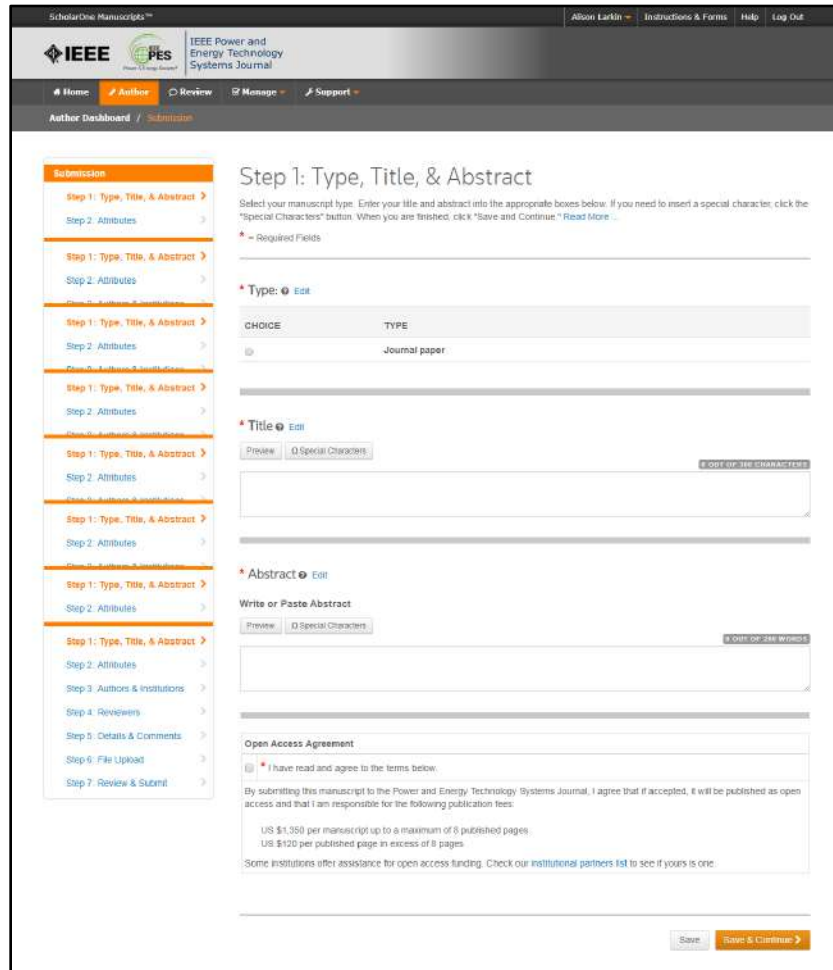
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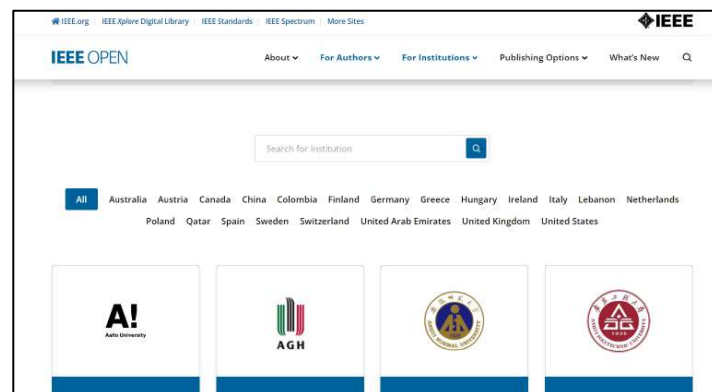
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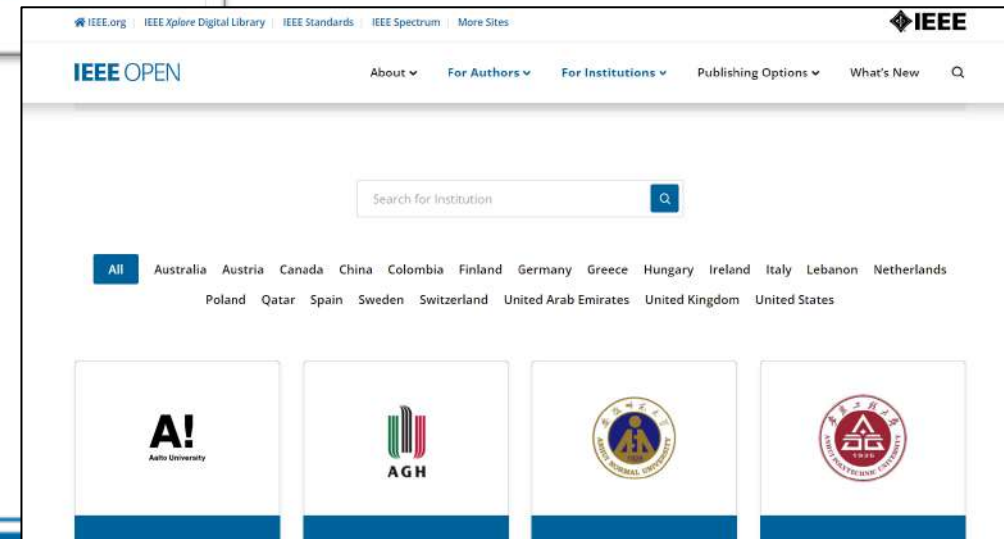
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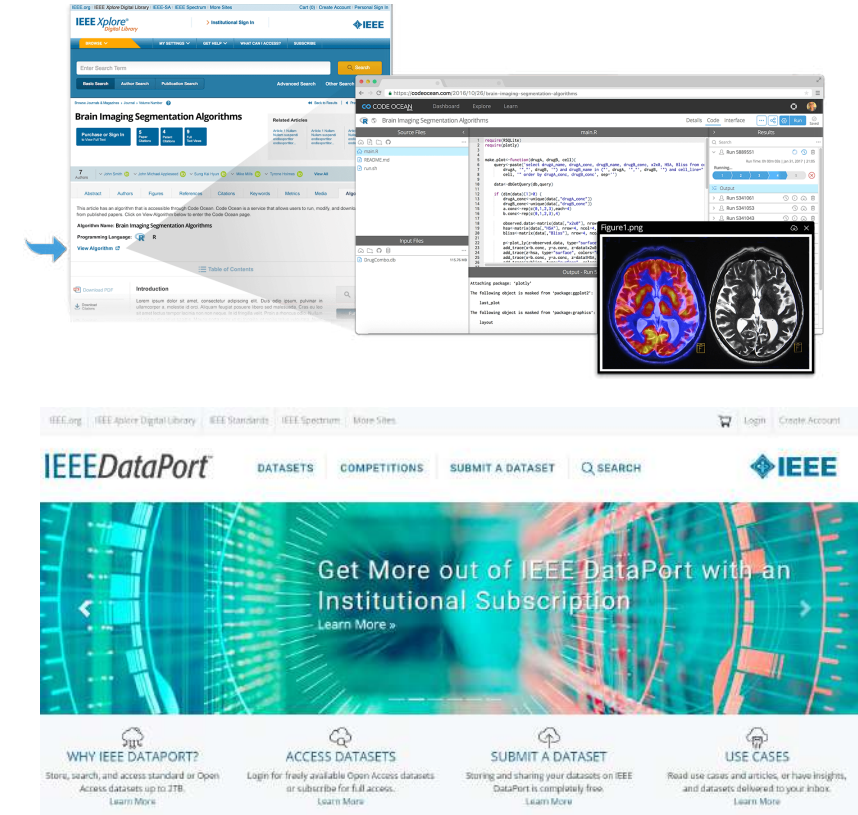
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The screenshot shows the IEEE Xplore article page for the paper "When Slepian Meets Fiedler: Putting a Focus on the Graph Spectrum" by Simon Van De Walle, Robin Dierckx, and Marie Claire Prete. The article is published in IEEE Signal Processing Letters, Volume 24, Issue 7, July 2017. The page includes an abstract, document sections, and a Code Ocean widget. The Code Ocean widget displays a 3D visualization of a tiger, which is the result of a graph Laplacian eigenvalue decomposition. The widget also shows a list of files and a "Run" button. The Code Ocean interface is a web-based environment for running and sharing code, featuring a file explorer, a command line, and a terminal. It allows users to run code in a Jupyter notebook, save the state as a "capsule", and share it with others. The Code Ocean widget on the article page provides a direct link to the capsule, allowing readers to interact with the code and data used in the paper.

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Technical University of Cluj-Napoca
Cluj-Napoca, Romania

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Biography

Lorand Szabó was born in Oradea, Romania, in 1960. He received the B.Sc. and Ph.D. degrees in electrical engineering from the Technical University of Cluj-Napoca, Cluj-Napoca, Romania, in 1985 and 1995, respectively. In 1990, he joined the Technical University of Cluj-Napoca as a Research and Design Engineer, where he has been with the Department of Electrical Machines and Drives since October 1999, where he was a Lecturer and then an Associate Professor. Currently he is a Full Professor. His current research interests include linear and variable reluctance electrical machines, fault-tolerant designs, fault detection and condition monitoring of electrical machines. *(Based on [document published on 20 November 2014](#)).*

Publications

86

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The screenshot shows a LinkedIn post by Josep M. Guerrero, a 1st-degree connection and Professor in Microgrids at Villum Investigator. The post is titled "SPACE MICROGRIDS: SATELLITES ENERGY, LUNAR BASES AND CLOSED (BIO)ECOSYSTEMS - A REVIEW OF OUR LAST PUBLICATIONS" and is associated with CROM, AAU Energy, and Aalborg University AAU Space. The post includes a video thumbnail titled "SPACE MICROGRIDS" showing a satellite in space. Below the video, the text reads "Space Microgrids: Satellites, Lunar Bases and Closed (Bio)Ecosystems" and "Josep M. Guerrero on LinkedIn • 2 min read". To the right of the video, there is a snippet of text: "tion for meeting the energy requirements ...". Below the video, there is a section titled "At Aalborg University, we are lucky to have a range of exciting research within different fields. One of them is CROM - Center for Research on Microgrids" with a logo for CROM (CENTER FOR RESEARCH ON MICROGRIDS). To the right of this section, there is a snippet of text: "Millimeter Wave Mobile Communications for 5G Cellular: II Will Work" and a list of authors: "Theodore S. Rappaport, Shu Sun, Rimma Maynor, Hang Zhao, Yanyu, Azad, Kaven Wang, George N. Wang, Jocelyn K. Scholz, Mathew, Sumathi, Felix, Gelleraoz, IEEE Access, Year: 2013 | Volume: 1". Below this, there is a video thumbnail titled "Read the article again: 2015 IEEE Donald G. Fink Award Recipient" showing a man in a red sweater. At the bottom right, there are three statistics: "4830 Paper Citations", "76 Patent Citations", and "307012 Full Text Views".

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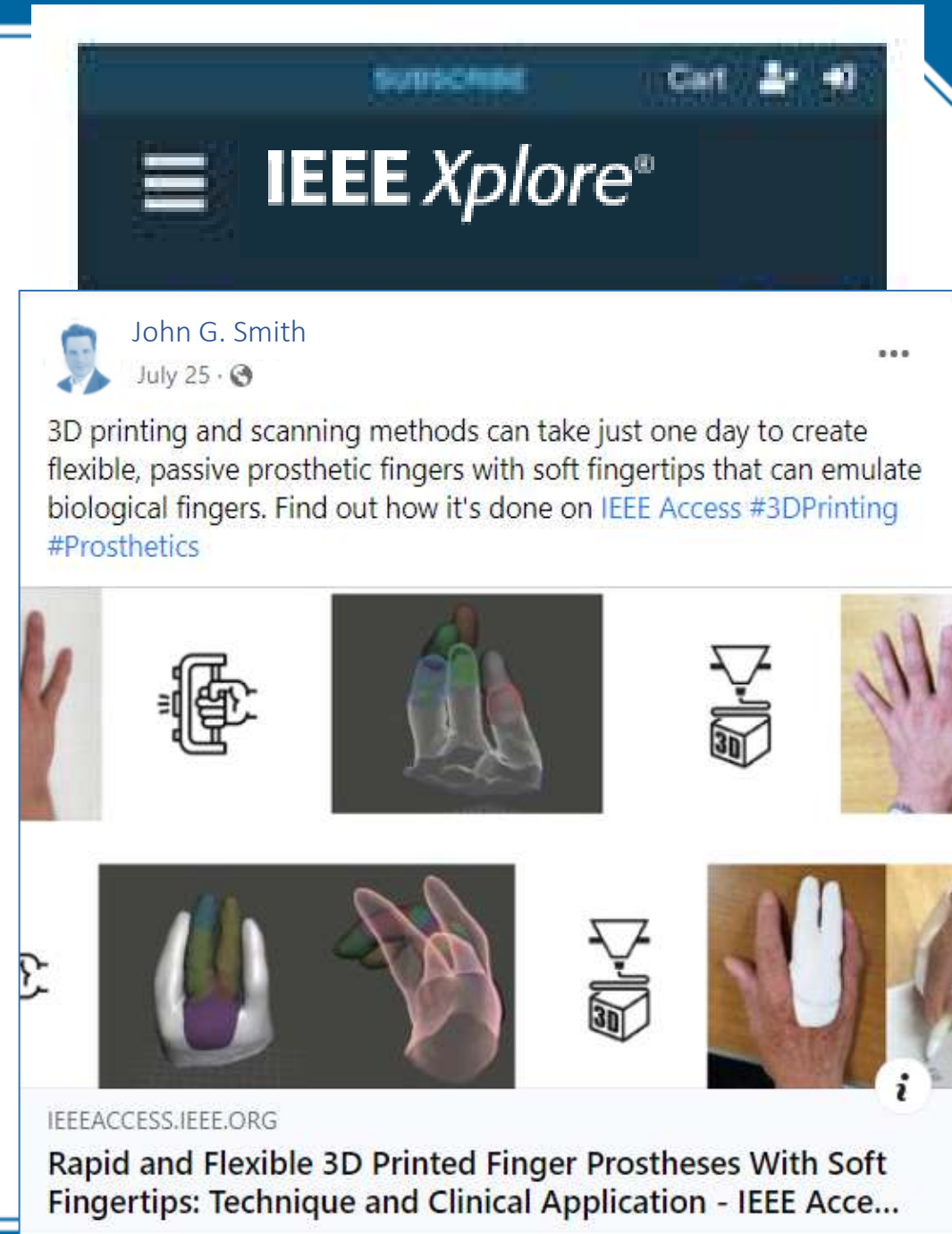
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The screenshot displays the IEEE Xplore interface. At the top, the IEEE Xplore logo is visible. Below it, a user profile for John G. Smith is shown, dated July 25. The main text of the post describes a 3D printing and scanning method for creating flexible, passive prosthetic fingers with soft fingertips. The text includes a link to the IEEE Access article and hashtags #3DPrinting and #Prosthetics. Below the text is a grid of six images: a hand, a 3D model of a hand, a 3D model of a finger, a 3D model of a hand, a 3D model of a hand, and a 3D model of a hand. The bottom of the image shows the IEEE Access logo and the article title: "Rapid and Flexible 3D Printed Finger Prostheses With Soft Fingertips: Technique and Clinical Application - IEEE Acce...".

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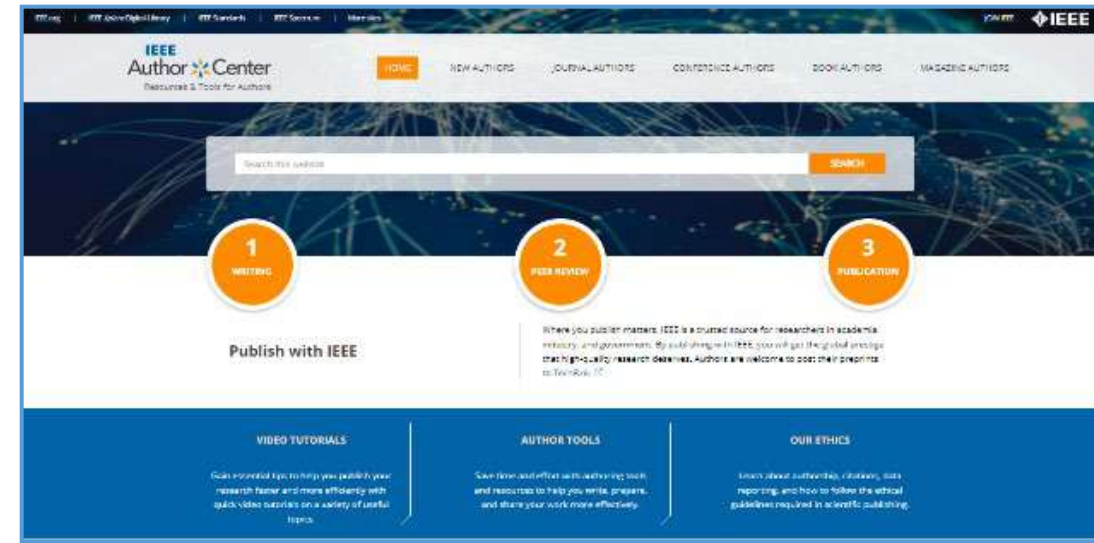
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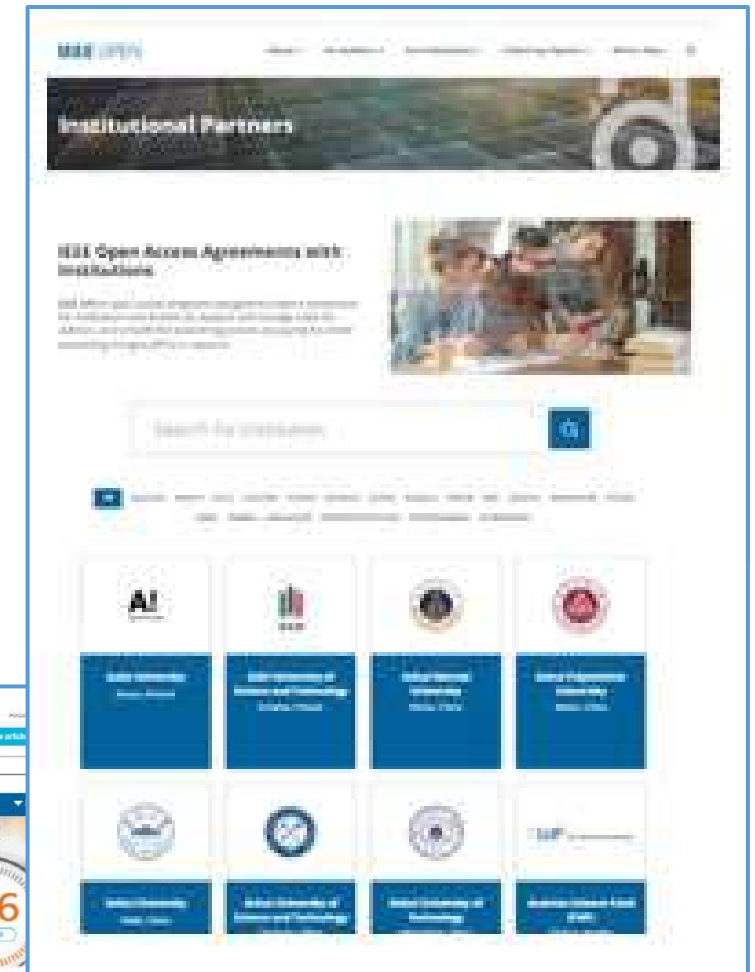
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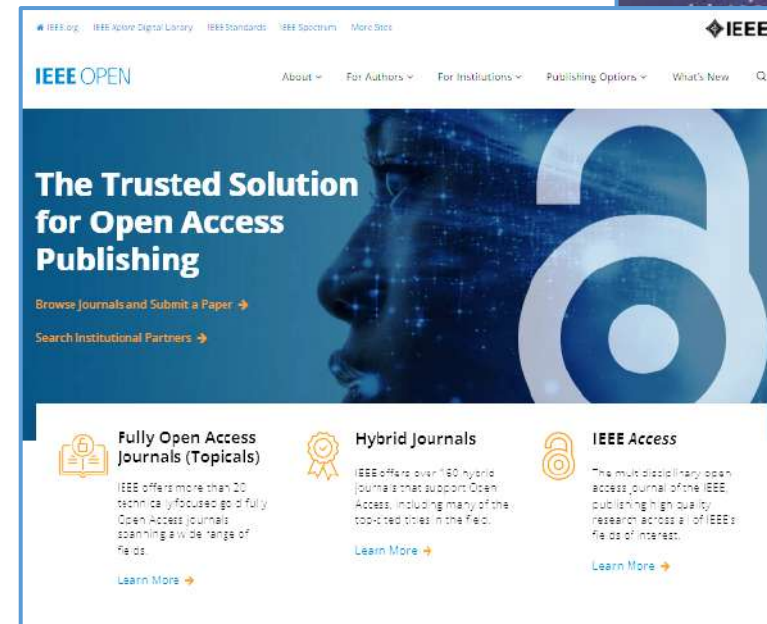
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